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	Application Number		10541447
INFORMATION BIOCH COURT	Filing Date		2006-04-07
INFORMATION DISCLOSURE	First Named Inventor	Pek-Y	ew Tan
STATEMENT BY APPLICANT (Not for submission under 37 CFR 1.99)	Art Unit		
(Not lot Submission under or or it 1.00)	Examiner Name		
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1	"IP mobility support for IPv4" http://www.ietf.org/rfc/rfc3344.txt	
2	"Mobility support in IPv6" http://www.ietf.org/internet-drafts/draft-ietf-mobileip-ipv6-19.txt	
3	"Dynamic Host Configuration Protocol for IPv6 (DHCPv6)" http://www.ietf.org/internet-drafts/draft-ietf-dhc-dhcpv6-28.txt	
4	"Diameter Mobile IPv6 Application" http://www.ietf.org/internet-draft-le-aaa-diameter-mobileipv6-02.txt	
5	"GPRD Tunnelling Protocol (GTP) across the Gn and Gp Interface (Release 5)" 3GPP TS 29.060 V5.3.0 (2002-09) ftp://ftp.3gpp.org/Specs/archive/29_series/	
6	"General Packet Radio Service (GPRS); Service description; Stage 2 (Release 5)" 3GPP TS 23.060 V5.2.0 (2002-06) ftp://ftp.3gpp.org/Specs/archive/23_series/	
7	"IP Multimedia Subsystem (IMS); Stage 2 (Release 5)" 3GPP TS 23.228 V5.6.0 (2002-09) ftp://ftp.3gpp.org/Specs/archive/23_series/	
8	"Diameter Base Protocol" http://www.ietf.org/internet-draft-ietf-aaa-diameter-15.txt	
9	"PPP Extensible Authentication Protocol (EAP)" http://ww.ietf.org/rfc/rfc2284.txt	
10	3GPP project http://www.3gpp.org	
11	3GPP2 project http://www.3gpp2.org	

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	12	"The Network Access Identifier" http://www.ietf.org/rfc/rfc2486.txt						
	13	"Numbering, addressing and identification (release 5)" 3GPP TS 23.003 V5.30 (2002-06) ftp://ftp.3gpp.org/Sepcs/archive/23_series/						
	14	"Port-Based Network Access Control" IEEE std 802.1X-2001 http://standards.ieee.org/getieee802/						
	15	"Diameter Extensible Authentication Protocol (EAP) Application" http://www.ietf.org/internet-drafts/draft-ietf-aaa-eap-00.txt						
	16	"Diameter NASREQ Application" http://ww.ietf.org/internet-drafts/draft-ietf-aa-diameter-nasreq-09.txt						
	17	IPv6 Stateless Address Autoconfiguration" http://www.ietf.org/rfc/rfc2462.txt						
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